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	DI INC DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
APPLICATION NO. 09/822,944	03/30/2001	Harry Q. Pon	42390P10075	6606
BLAKELY SOKOLOFF TAYLOR & ZAFMAN 12400 WILSHIRE BOULEVARD, SEVENTH FLOOR			EXAMINER ANDUJAR, LEONARDO	
LOS ANGELI	ES, CA 90025		ART UNIT	PAPER NUMBER
			2826	

DATE MAILED: 07/01/2002

Please find below and/or attached an Office communication concerning this application or proceeding.

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·		Applica	ation No.	Applicant(s)	
	▼	09/822	2,944	PON, HARRY Q.	
	Office Action Summary	Exami	ner	Art Unit	
		Leonar	do Andújar	2826	
	The MAILING DATE of this commu	nication appears on	the cover sheet wi	th the correspondence ad	dress
Period fo		-00 DEDLY 10 0E	TO EVOIDE 2 M	ONTH(S) FROM	
THE N - Exter after - If the - If NO - Failu	ORTENED STATUTORY PERIOD F MAILING DATE OF THIS COMMUN asions of time may be available under the provision SIX (6) MONTHS from the mailing date of this com period for reply specified above is less than thirty (period for reply is specified above, the maximum set to reply within the set or extended period for reply received by the Office later than three months and patent term adjustment. See 37 CFR 1.704(b).	IICATION. s of 37 CFR 1.136(a). In no munication. 30) days, a reply within the statutory period will apply an acceptable by statute. Cause the	o event, however, may a r statutory minimum of thirt and will expire SIX (6) MON application to become AE	eply be timely filed y (30) days will be considered timely THS from the mailing date of this co	y ommunication.
1)[Responsive to communication(s)	filed on <u>09 October</u>	<u> 2001</u> .		
2a)□	This action is FINAL .	2b) This action			
3)	Since this application is in condition closed in accordance with the pration of Claims	on for allowance exc ctice under <i>Ex part</i> e	cept for formal ma e Q <i>uayle</i> , 1935 C.	tters, prosecution as to th D. 11, 453 O.G. 213.	ne merits is
-	Claim(s) 1-27 is/are pending in the	e application.			
	4a) Of the above claim(s) <u>19-27</u> is/a		consideration.		
	Claim(s) is/are allowed.				
, 	Claim(s) <u>1-18</u> is/are rejected.				
•	Claim(s) is/are objected to.				
	Claim(s) are subject to rest	riction and/or election	on requirement.		
	ion Papers				
9)⊡	The specification is objected to by t	the Examiner.			
10)	The drawing(s) filed on is/are	e: a)□ accepted or t	o) objected to by	the Examiner.	
	Applicant may not request that any c	objection to the drawir	ng(s) be held in abey	ance. See 37 CFR 1.85(a)	•
11)	The proposed drawing correction fi			disapproved by the Exami	ner.
	If approved, corrected drawings are	required in reply to th	is Office action.		
12)	The oath or declaration is objected	to by the Examiner			
	under 35 U.S.C. §§ 119 and 120				
13)	Acknowledgment is made of a cla	im for foreign priorit	y under 35 U.S.C.	§ 119(a)-(d) or (f).	
а) All b) Some * c) None of	f:			/
	1. Certified copies of the priori				
	2. Certified copies of the priori	ity documents have	been received in	Application No.	
*	3 Copies of the certified copies application from the Inte	ernational Bureau (I ction for a list of the	certified copies no	ot received / N	
14)	Acknowledgment is made of a clair	n for domestic prior	ity under 35 U.S.C	c. § 119(e) (to a provision	al application).
	a) The translation of the foreign Acknowledgment is made of a claim	language provision	al application has	been received.	
Attachme					
2) No	tice of References Cited (PTO-892) tice of Draftsperson's Patent Drawing Reviev ormation Disclosure Statement(s) (PTO-1449	w (PTO-948) 9) Paper No(s) <u>6</u> .	4) Interview 5) Notice (6) Other:	w Summary (PTO-413) Paper N of Informal Patent Application (F	No(s) · PTO-152)
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DETAILED ACTION

Acknowledgment

1. The Amendment filed on 10/09/2001, paper no. 5 has been entered. The present Office action is made with all the suggested amendments being fully considered. Accordingly, pending in this Office action are claims 1-27.

Election/Restrictions

- 2. Restriction to one of the following inventions is required under 35 U.S.C. 121:
 - I. Claims 1-18, drawn to a semiconductor device, classified in class 257, subclass 786.
 - II. Claims 19-27, drawn to a method of manufacturing a semiconductor device, classified in class 438, subclass 612.
- 3. The inventions are distinct, each from the other because of the following reasons: Inventions II and I are related as process of making and product made. The inventions are distinct if either or both of the following can be shown: (1) that the process as claimed can be used to make other and materially different product or (2) that the product as claimed can be made by another and materially different process (MPEP § 806.05(f)). In the instant case, unpatentability of the Group I invention would not necessarily imply unpatentability of the Group II invention, because the device of Group I invention could be made by a process materially different from that of the Group II invention. For example, the process of claim 20 can be materially altered by deposit the insulating layer over the bond wire without covering its ends.

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4. Because these inventions are distinct for the reasons given above and have acquired a separate status in the art as shown by their different classification, the fields of search are not co-extensive and separate examination would be require, restriction for examination purposes as indicated is proper.

- 5. Applicant is advised that the response to this requirement to be complete must include an election of the invention to be examined even though the requirement be traversed (37 CFR 1.143).
- 6. Applicant is reminded that upon the cancellation of claims to a non-elected invention, the inventorship must be amended in compliance with 37 CFR 1.48(b) if one or more of the currently named inventors is no longer an inventor of at least one claim remaining in the application. Any amendment of inventorship must be accompanied by a diligently-filed petition under 37 CFR 1.48(b) and by the fee required under 37 CFR 1.17(h).
- During a telephone conversation with John Travis on 06/14/2002 a provisional election was made without traverse to prosecute the invention of I, claims 1-18. Affirmation of this election must be made by applicant in replying to this Office action. Claims 19-27 withdrawn from further consideration by the examiner, 37 CFR 1.142(b), as being drawn to a non-elected invention.

Specification

8. The title of the invention is not descriptive. A new title is required that is clearly indicative of the invention to which the claims are directed.

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Claim Rejections - 35 USC § 112

The following is a quotation of the second paragraph of 35 U.S.C. 112: 9.

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

- Claim 16 is rejected under 35 U.S.C. 112, second paragraph, as being indefinite 10. for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.
- Claim 16 recites the limitation "said substrate" in line 1. There is insufficient 11. antecedent basis for this limitation in the claim.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that 12. form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in-

- (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effect under this subsection of a national application published under section 122(b) only if the international application designating the United States was published under Article 21(2)(a) of such treaty in the English language; or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that a patent shall not be deemed filed in the United States for the purposes of this subsection based on the filing of an international application filed under the treaty defined in section 351(a).
- Claims 1-3 and 6-14 are rejected under 35 U.S.C. 102(e) as being anticipated by 13. Horiuchi et al. (US 6,084,295).
- Regarding claim 1, Horiuchi (e.g. figs. 1-3) shows an apparatus comprising: 14.
 - A bond wire 20;
 - An insulating material 30 coating the wire bond;
 - And a first end of the wire bond connected to a bond pad.

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15. Regarding claim 2, Horiuchi discloses that the bond wire is made of gold (col. 4/lls. 26-37).

- 16. Regarding claim 3, Horiuchi discloses that the insulating material comprises a polymer (col. 4/lls. 26-37).
- 17. Regarding claim 6, Horiuchi shows that the bond pad is connected to an integrated circuit (abstract).
- 18. Regarding claim 7, Horiuchi shows that the bond pad is connected to a substrate (e.g. fig. 1).
- 19. Regarding claim 8, Horiuchi (e.g. figs. 1-3) shows an apparatus comprising:
 - > A first bond wire 20;
 - An insulating material 30 coating the wire bond;
 - A first end of the wire bond connected to a bond pad;
 - > And a second bond wire crossing the first bond wire.
- 20. Regarding claim 9, Horiuchi shows that the wires comprises an insulating material coating the second wire bond (e.g. fig. 3).
- 21. Regarding claim 10, Horiuchi shows that the first bond wire touches the second bond wire (e.g. fig. 1).
- 22. Regarding 11, Horiuchi (e.g. figs. 1-3) shows an integrated circuit assembly comprising:
 - An integrated circuit 10;
 - A substrate 5;
 - > A bond wire 20 connected to the integrated circuit and the substrate;

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And an insulating material 30 coating the wire bond.

- 23. Regarding claim 12, Horiuchi shows that the substrate 5 is a printed circuit board (co. 3/II. 32).
- 24. Regarding claim 13, Horiuchi discloses that the insulating material comprises a polymer (col. 4/lls. 26-37).
- 25. Regarding claim 14, Horiuchi discloses that the bond wire is made of gold (col. 4/lls. 26-37).

Claim Rejections - 35 USC § 103

- 26. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 27. Claims 4 and 5 are rejected under 35 U.S.C. 103(a) as being unpatentable over Horiuchi et al. (US 6,084,295).
- 28. Regarding claim 4, Horiuchi shows most aspects of the instant invention (see comments above), except for the specific insulating coating thickness claimed by the applicant i.e., the thickness of the insulating material on the bond wire is in the range of approximately 0.2 micrometers to 0.6 micrometers. Horiuchi, however, discloses that the thickness of the bond wire is 5 micrometers (col. 4/lls. 26-37). Although Horiuchi does not specify the same insulating thickness as those claimed by the applicants, thickness differences are considered obvious design choices and are not patentable unless unobvious or unexpected results are obtained from these changes. Accordingly,

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it would be an obvious matter of design choice to select a suitable thickness for the insulating coating discloses by Horiuchi, since the insulating thickness is variable of importance subject to routine experimentation and optimization and it is not inventive to discover the optimum or workable ranges by routine experimentation. In re Aller, 220 F.2d 454, 105 USPQ 233, 235. Furthermore, it appears that the insulating differences between Horiuchi and the claimed invention produce no functional differences and therefore would have been obvious. Note In re Leshin, 125 USPQ 416.

- 29. Applicant's claims 5, does not distinguish over the Horiuchi reference regardless of the process used to connect the wire bond to the bond pad, because only the final product is relevant, not the process of making such ultrasonic bonding. Note that a "product by process" claim is directed to the product per se, no matter how actually made, In re Hirao, 190 USPQ 15 at 17 (footnote 3). See also In re Brown, 173 USPQ 685; In re Luck, 177 USPQ 523; In re Fessmann, 180 USPQ 324; In re Avery, 186 USPQ 161; In re Wertheim, 191 USPQ 90 (209 USPQ 554 does not deal with this issue); and In re Marosi et al., 218 USPQ 289, all of which make it clear that it is the patentability of the final product per se which must be determined in a "product by process" claim, and not the patentability of the process, and that an old or obvious product produced by a new method is not patentable as a product, whether claimed in "product by process" claims or not. Note that applicant has the burden of proof in such cases, as the above caselaw makes clear. See also MPEP 706.03(e).
- 30. Claims 15-18, are rejected under 35 U.S.C. 103(a) as being unpatentable over Horiuchi et al. (US 6,084,295) in view of Takiar (US 5,422,435)

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31. Regarding 15, Horiuchi (e.g. figs. 1-3) shows an integrated circuit assembly comprising:

An integrated circuit 10;

A substrate 5;

> A bond wire 20 connected to the integrated circuit and the substrate;

And an insulating material 30 coating the wire bond.

32. However, Horiuchi does not disclose a second integrated circuit. Takiar (e.g. fig.

5) shows a package comprising a first integrated circuit connected to a second

integrated circuit by bond wires. Takiar discloses that this type of embodiment provides

a single circuit assembly. Furthermore, Takiar discloses that this type of arrangement is

used to decrease the size and weight of the device, as well as to improve its

performance (col. 2/lls. 3-9). It would have been obvious to one of ordinary skill in the

art at the time the invention was made to include a second integrated circuit in

Horiuchi's invention in order to provide a single circuit assembly having a decreased

size and weight as suggested by Takiar.

33. Regarding claim 16 (as understood), Horiuchi shows that the substrate 5 is a

printed circuit board (co. 3/II. 32).

34. Regarding claim 17, Horiuchi discloses that the insulating material comprises a

polymer (col. 4/lls. 26-37).

35. Regarding claim 18, Horiuchi discloses that the bond wire is made of gold (col.

4/lls. 26-37).

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Conclusion

- Papers related to this application may be submitted directly to Art Unit 2826 by 36. facsimile transmission. Papers should be faxed to Art Unit 2826 via the Art Unit 2826 Fax Center located in Crystal Plaza 4, room 3C23. The faxing of such papers must conform to the notice published in the Official Gazette, 1096 OG 30 (15 November 1989). The Art Unit 2826 Fax Center number is (703) 308-7722 or -7724. The Art Unit 2826 Fax Center is to be used only for papers related to Art Unit 2826 applications.
- Any inquiry concerning this communication or earlier communications from the 37. examiner should be directed to Leonardo Andújar at (703) 308-0080 and between the hours of 9:00 AM to 5:00 PM (Eastern Standard Time) Monday through Friday or by email via Leonardo. Andujar@uspto.gov. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nathan Flynn, can be reached on (703) 308-6601.
- Any inquiry of a general nature or relating to the status of this application should 38. be directed to the Group 2800 Receptionist at (703) 305-3900.
- The following list is the Examiner's field of search for the present Office Action: 39.

Help on Security	PelC
U.S. Class / Subclass (es): 257/723, 782 and 786	06/02
Other Documentation:	
Electronic Database(s): East (USPAT, US PGPUB, JPO, EPO, Derwent, IBM TDB)	06/02

Leonardo Andújar

Patent Examiner Art Unit 2826

6/18/02